

Features

- Low on resistance
- Low reverse transfer capacitances
- 100% single pulse avalanche energy test
- 100% ΔVDS test
- Pb-Free plating / Halogen-Free / RoHS compliant

Key Parameters

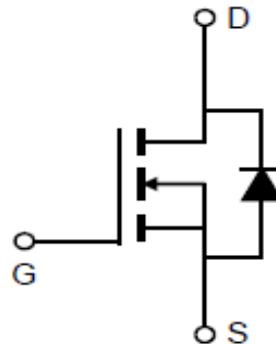
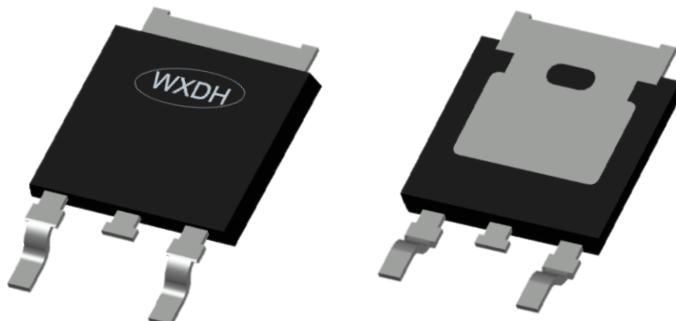
V _{DS}	100V
R _{DS(on)typ.}	15mΩ
I _D	50A
C _{iss@10V}	1076pF
Q _{gd}	2nC

Applications

- Motor Control and Drive
- Charge/Discharge for Battery Management System
- Synchronous Rectifier for SMPS



TO-252



Marking & Packing Information

Part #	Package	Marking	Tube/Reel	Qty(pcs)
DHS180N10LD	TO-252	DHS180N10LD	Reel	2500/box

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V _{DS}	100	V
Gate-Source voltage	V _{GS}	±20	V
Continuous drain current	I _D	50	A
T _C = 25°C		35	
T _C = 100°C			
Pulsed drain current (T _C = 25°C, t _p limited by T _{jmax})	I _D pulse	200	A
Avalanche energy, single pulse (L=0.5mH, R _g =25Ω) ^[1]	E _{AS}	90	mJ
Power dissipation (T _C = 25°C)	P _{tot}	68	W
Operating junction and storage temperature	T _j , T _{stg}	-55...+175	°C

Notes: 1. EAS was tested at T_j = 25°C, L = 0.5mH, I_d=13A.

Thermal Resistance

Parameter	Symbol	Max	Unit
Thermal resistance, junction – case.	R _{thJC}	2.20	°C/W
Thermal resistance, junction – ambient(min. footprint)	R _{thJA}	98	

Electrical Characteristic (at T_j = 25 °C, unless otherwise specified)

Static Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Drain-source breakdown voltage	BV _{DSS}	100	-	-	V	V _{GS} =0V, I _D =250uA
Gate threshold voltage	V _{GS(th)}	1.0	-	2.3	V	V _{DS} =V _{GS} , I _D =250uA
Zero gate voltage drain current	I _{DSS}	-	-	1	μA	V _{DS} =100V, V _{GS} =0V
		-	-	100		T _j =25°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	15	20	mΩ	V _{GS} =10V, I _D =20A,
		-	23	30		T _j =25°C
						V _{GS} =4.5V, I _D =20A,

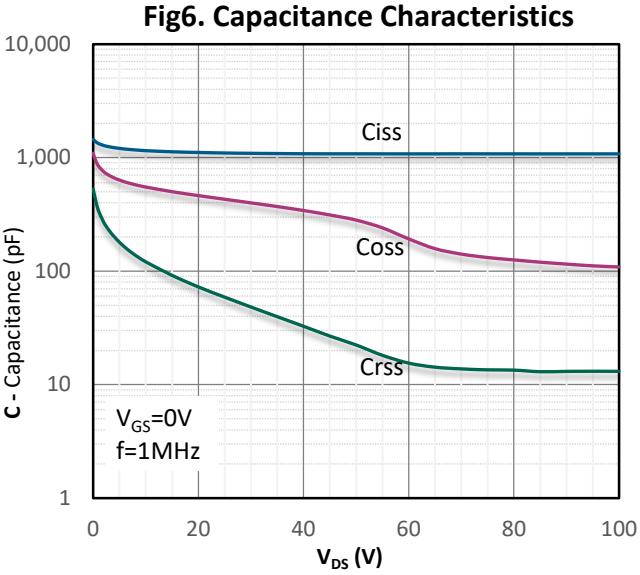
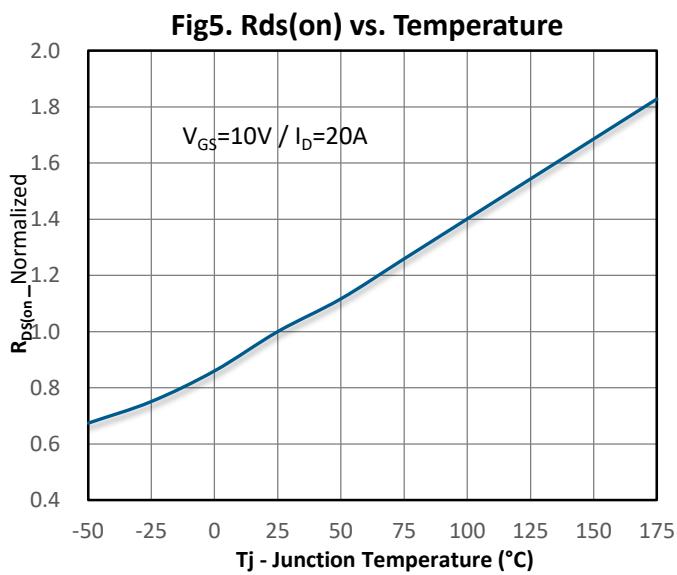
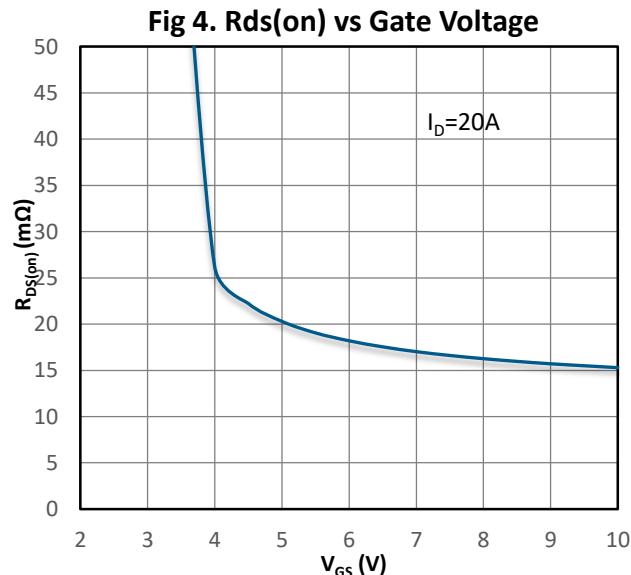
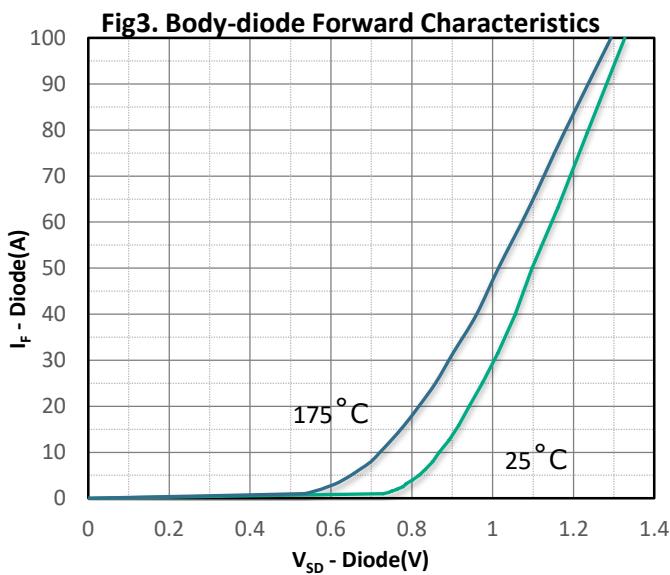
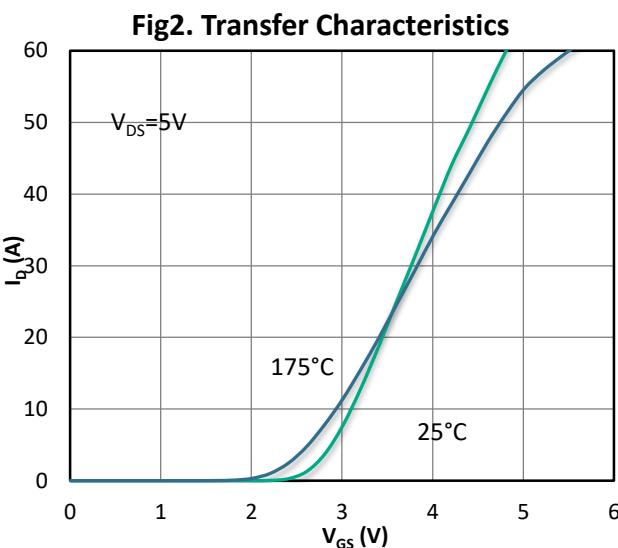
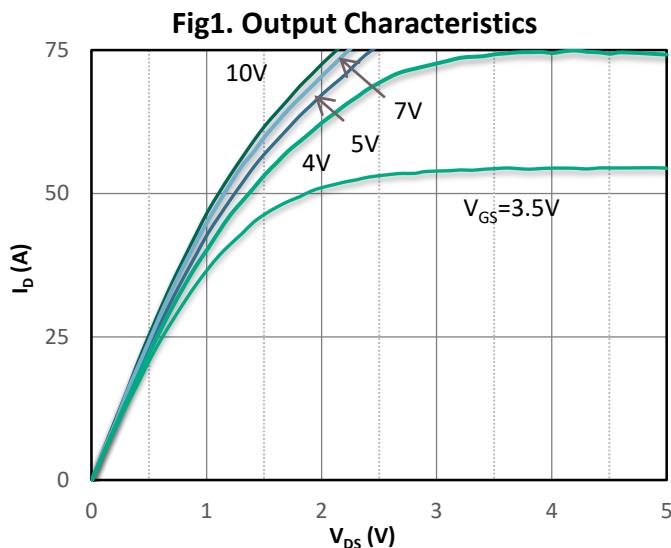
Dynamic Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Input Capacitance	C _{iss}	-	1076	-	pF	V _{GS} =0V, V _{DS} =50V, f=1MHz
Output Capacitance	C _{oss}	-	281	-		
Reverse Transfer Capacitance	C _{rss}	-	22	-		
Gate Total Charge	Q _G	-	19	-	nC	V _{GS} =10V, V _{DS} =50V, I _D =20A
Gate-Source charge	Q _{gs}	-	5	-		
Gate-Drain charge	Q _{gd}	-	2	-		
Gate plateau voltage	V _{plateau}	-	3.2	-	V	
Turn-on delay time	t _{d(on)}	-	7	-	ns	V _{GS} =10V, V _{DD} =50V, R _{G_ext} =3Ω
Rise time	t _r	-	18	-		
Turn-off delay time	t _{d(off)}	-	19	-		
Fall time	t _f	-	5	-		
Gate resistance	R _G	-	2.3	-	Ω	V _{GS} =0V, V _{DS} =0V, f=1MHz

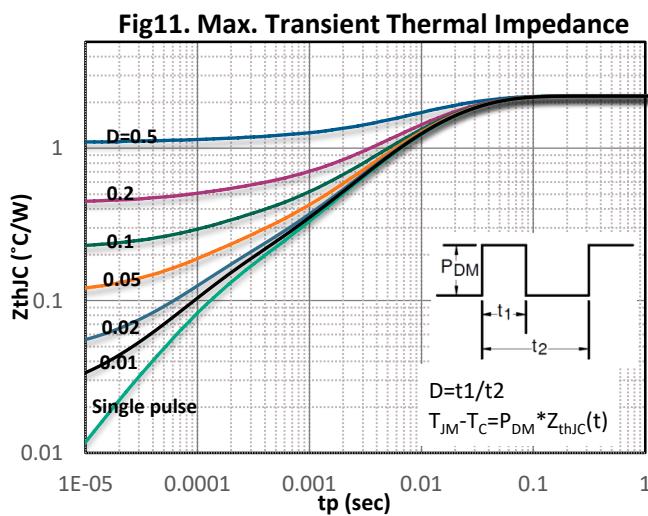
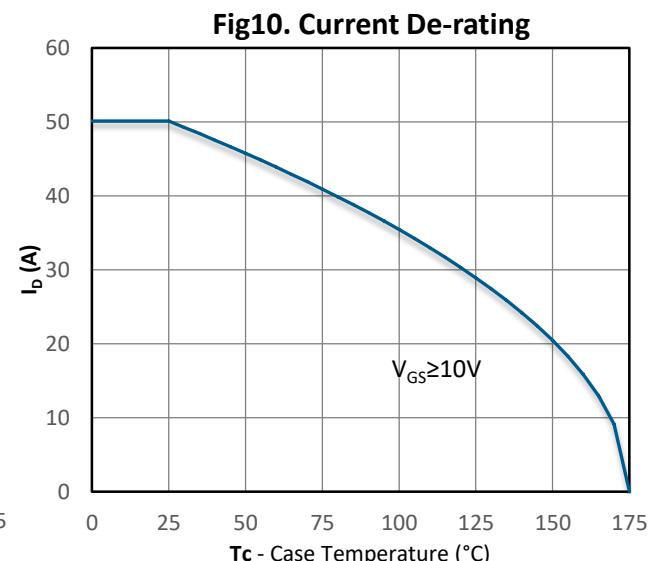
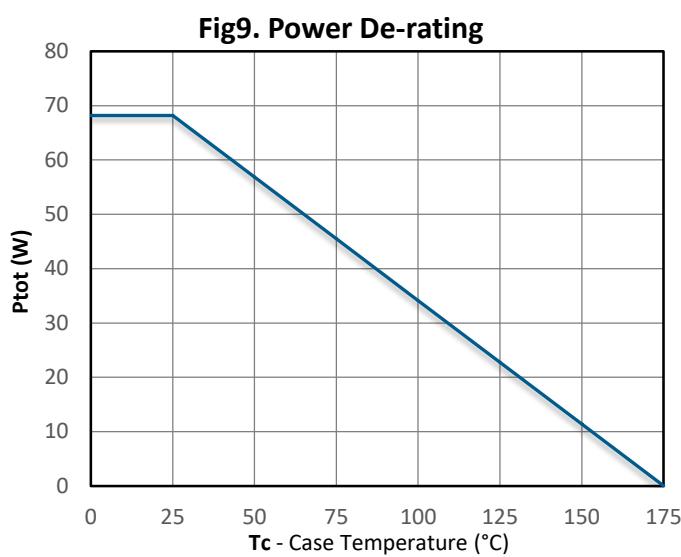
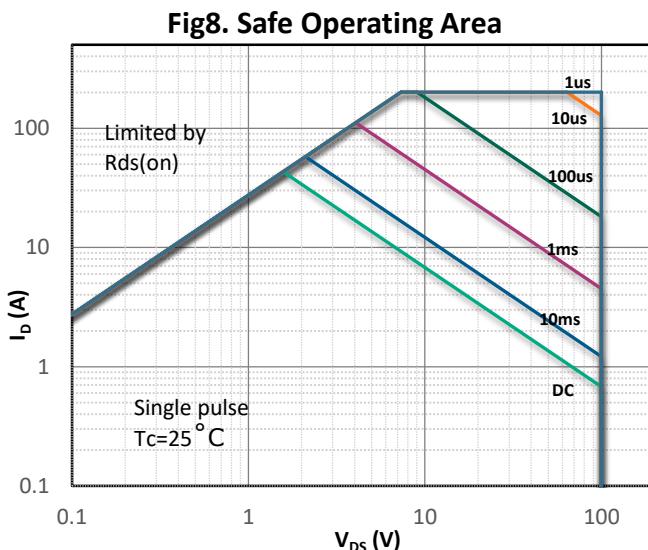
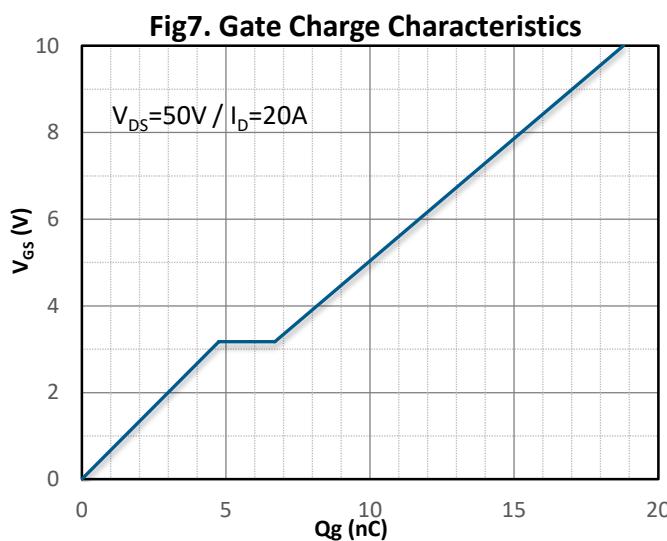
Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Diode Max Current	I _S		-	50	A	-
Diode Forward Voltage	V _{SD}	-	-	1.2	V	V _{GS} =0V, I _{SD} =20A
Diode Reverse Recovery Time	t _{rr}	-	42	-	ns	I _F =20A, dI/dt=100A/μs
Diode Reverse Recovery Charge	Q _{rr}	-	53	-	nC	

Typical Characteristics Diagram

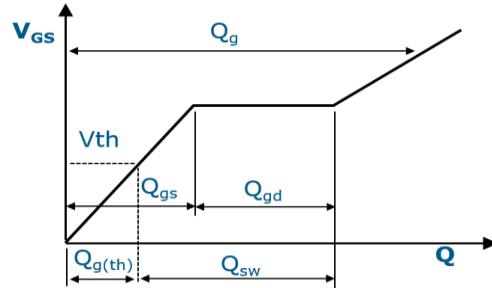
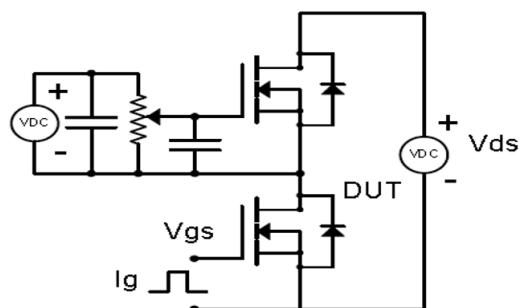


Typical Characteristics Diagram

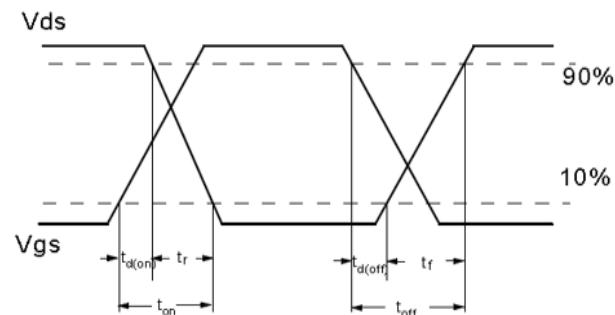
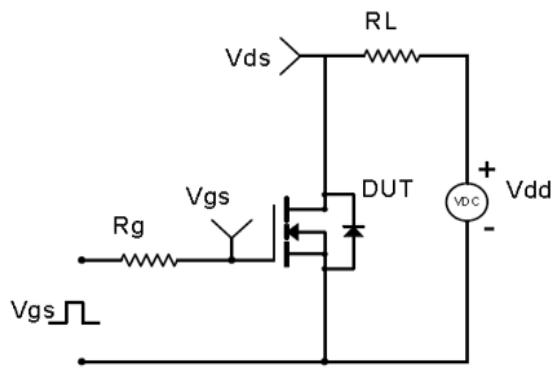


Test Circuit & Waveform

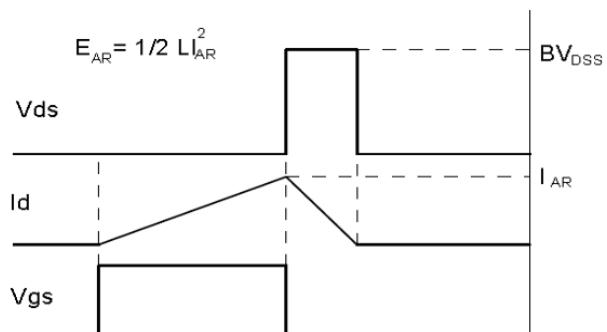
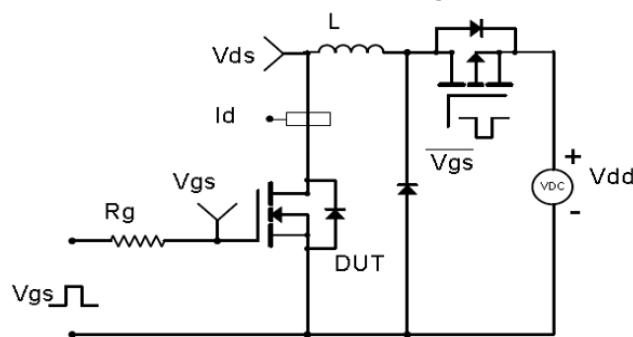
Gate Charge Test Circuit & Waveform



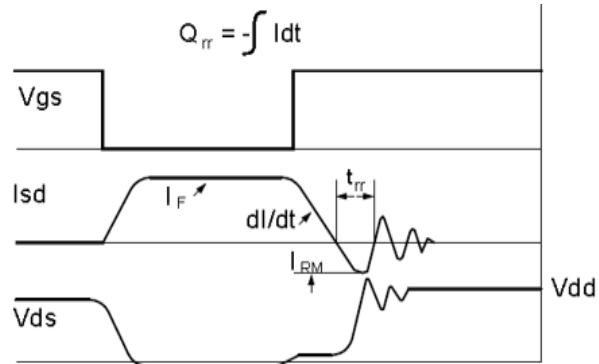
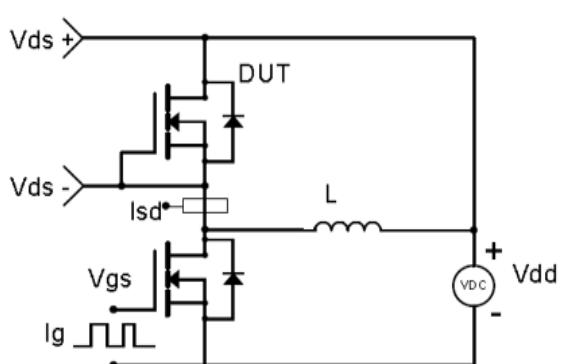
MOSFET Switching Test Circuit & Waveform



E_{AS} Test Circuit & Waveform

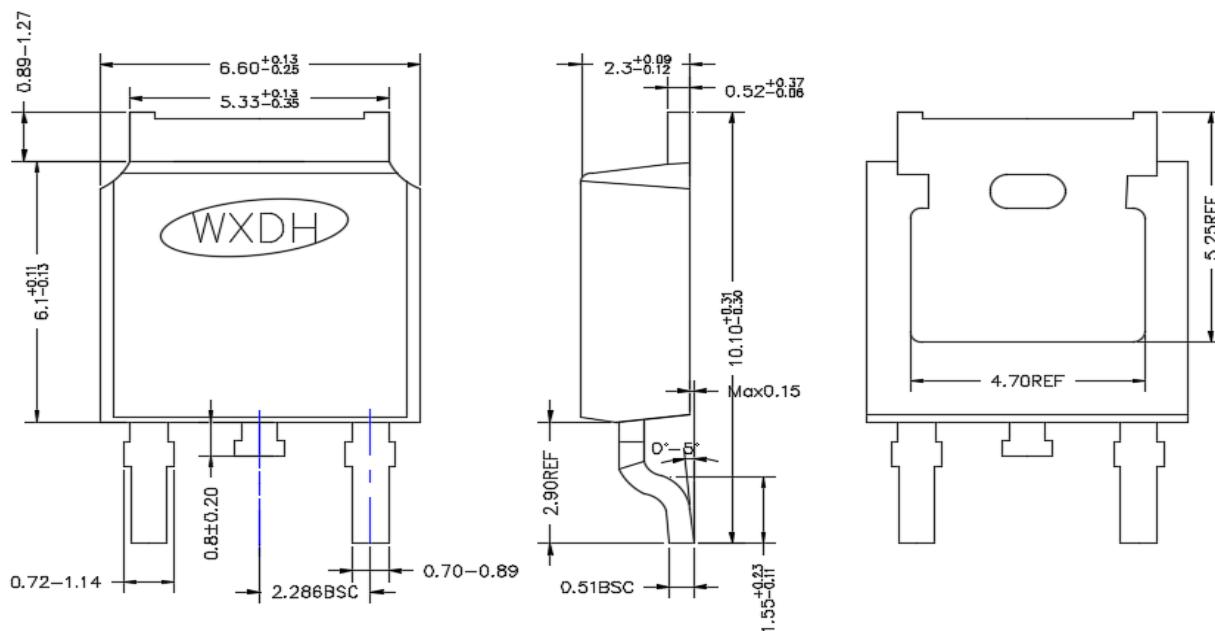


Diode Recovery Test Circuit & Waveform



Package Outline : TO-252

*Dimensions in mm



Revision History

Revison	Date	Major changes
1.0	2023/6/26	Release of formal version

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as aviation, aerospace, life-support devices or systems.

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